TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74VHC125F, TC74VHC125FT, TC74VHC125FK TC74VHC126F, TC74VHC126FT, TC74VHC126FK

TC74VHC125F/FT/FK Quad Bus Buffer TC74VHC126F/FT/FK Quad Bus Buffer

The TC74VHC125/126 are high speed CMOS QUAD BUS BUFFERs fabricated with silicon gate  $C^2MOS$  technology.

They achieve the high speed operation similar to equivalent Bipolar Shottky TTL while maintaining the CMOS low power dissipation.

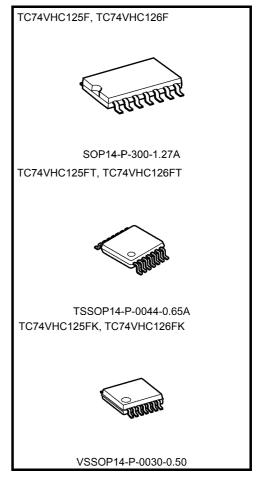
The TC74VHC125 requires the 3-state control input  $\overline{G}$  to be set high to place the output into the high impedance state, whereas the TC74VHC126 requires the control input G to be set low to place the output into high impedance.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up.

This circuit prevents device destruction due to mismatched supply and input voltages.

#### **Features**

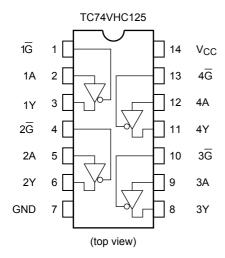
- High speed:  $t_{pd} = 3.8 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A$  (max) at  $T_a = 25$ °C
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range:  $V_{CC (opr)} = 2 \text{ to } 5.5 \text{ V}$
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with 74ALS125/126

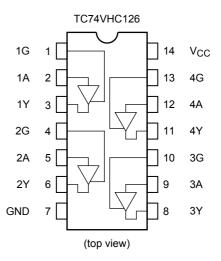


Weight

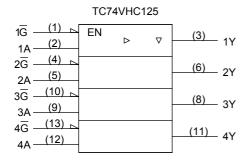
SOP14-P-300-1.27A : 0.18 g (typ.) TSSOP14-P-0044-0.65A : 0.06 g (typ.) VSSOP14-P-0030-0.50 : 0.02 g (typ.)

### **Pin Assignment**





## **IEC Logic Symbol**



	TC7	4VHC	126	
1G — (1) 1A — (2)	EN	D	∇	(3) 1Y
2G <u>(4)</u> 2A <u>(5)</u>				(6) 2Y
3G <u>(10)</u> 3A <u>(9)</u>				(8) 3Y
4G <u>(13)</u> 4A <u>(12)</u>				(11) 4Y

### **Truth Table**

#### **TC74VHC125**

Inputs		Output
Ġ	Α	Y
Н	Χ	Z
L	L	L
L	Н	Н

X: Don't care

Z: High impedance

#### **TC74VHC126**

Inputs		Output
G	Α	Υ
L	Х	Z
Н	L	L
Н	Н	Н

X: Don't care

Z: High impedance



## **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	−0.5 to 7.0	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	-20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>cc</sub> /ground current	Icc	±50	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	−65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	T <sub>opr</sub>	−40 to 85	°C	
Input rise and fall time	dt/dv	0 to 100 ( $V_{CC} = 3.3 \pm 0.3 \text{ V}$ )	ns/V	
input rise and fail time	αυαν	0 to 20 ( $V_{CC} = 5 \pm 0.5 \text{ V}$ )	ns/V	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

3



## **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = −40 to 85°C		Unit
	,			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
High-level input				2.0	1.50	-	_	1.50	_	
voltage	$V_{IH}$	_		3.0 to 5.5	V <sub>CC</sub> × 0.7	ı	_	V <sub>CC</sub> × 0.7	_	V
Low-level input				2.0	_	_	0.50	_	0.50	
voltage	V <sub>IL</sub>	_		3.0 to 5.5	_	_	V <sub>CC</sub> × 0.3	_	V <sub>CC</sub> × 0.3	V
				2.0	1.9	2.0	_	1.9	_	
		$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OH} = -50 \mu A$	3.0	2.9	3.0	_	2.9	_	
High-level output voltage	$V_{OH}$			4.5	4.4	4.5	_	4.4	_	V
ŭ			I <sub>OH</sub> = -4 mA	3.0	2.58	_	_	2.48	_	
			$I_{OH} = -8 \text{ mA}$	4.5	3.94	_	_	3.80	_	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		2.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 50 \mu A$	3.0	_	0.0	0.1	_	0.1	
Low-level output voltage	$V_{OL}$			4.5	_	0.0	0.1	_	0.1	V
ŭ			I <sub>OL</sub> = 4 mA	3.0	_	_	0.36	_	0.44	
			$I_{OL} = 8 \text{ mA}$	4.5	_	_	0.36	_	0.44	
3-state output off-state current	loz	$V_{IN} = V_{IH}$ or $V_{IL}$ $V_{OUT} = V_{CC}$ or GND		5.5	_	_	±0.25	_	±2.50	μА
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5			±0.1		±1.0	μА
Quiescent supply current	ICC	$V_{IN} = V_{CC}$ or GNI	)	5.5	_	_	4.0	_	40.0	μА



#### AC Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
	-,		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	J
			22.02	15	_	5.6	8.0	1.0	9.5	
Propagation delay	$t_{pLH}$		$3.3 \pm 0.3$	50	_	8.1	11.5	1.0	13.0	ns
time	$t_{pHL}$	_	5.0 ± 0.5	15	_	3.8	5.5	1.0	6.5	115
			5.0 ± 0.5	50	_	5.3	7.5	1.0	8.5	
			$3.3\pm0.3$	15	_	5.4	8.0	1.0	9.5	- ns
Output enable time	t <sub>pZL</sub> t <sub>pZH</sub>	$R_L = 1 k\Omega$		50	_	7.9	11.5	1.0	13.0	
			5.0 ± 0.5	15	_	3.6	5.1	1.0	6.0	
				50	_	5.1	7.1	1.0	8.0	
Output disable time	t <sub>pLZ</sub>	R <sub>L</sub> = 1 kΩ	$3.3 \pm 0.3$	50	_	9.5	13.2	1.0	15.0	ns
Output disable time	$t_{pHZ}$		$5.0 \pm 0.5$	50	_	6.1	8.8	1.0	10.0	115
Output to output skew	t <sub>osLH</sub>	(N=+= 4)	$3.3 \pm 0.3$	50	_	_	1.5	_	1.5	20
Output to output skew	t <sub>osHL</sub>	(Note 1)	$5.0 \pm 0.5$	50	_	_	1.0	_	1.0	ns
Input capacitance	C <sub>IN</sub>		_		_	4	10	_	10	pF
Output capacitance	C <sub>OUT</sub>		_		_	6	_	_	_	pF
Power dissipation capacitance (Note 2)		TC74VHC125		_	14	_	_	_		
	C <sub>PD</sub>	TC74VHC126	TC74VHC126		_	15	_	_	_	- pF

Note 1: Parameter guaranteed by design.

$$t_{\text{OSLH}} = |t_{\text{pLHm}} - t_{\text{pLHn}}|, \, t_{\text{OSHL}} = |t_{\text{pHLm}} - t_{\text{pHLn}}|$$

Note 2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

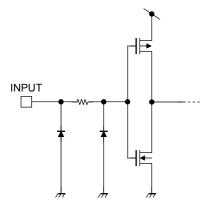
$$I_{CC\;(opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4 \;(per\;gate)$$

## Noise Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Ta =	- Unit		
Characteristics	Symbol		V <sub>CC</sub> (V)	Тур.	Limit	Offic
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	0.3	0.8	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-0.3	-0.8	V
Minimum high level dynamic input voltage	V <sub>IHD</sub>	C <sub>L</sub> = 50 pF	5.0	_	3.5	V
Maximum low level dynamic input voltage	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	_	1.5	V



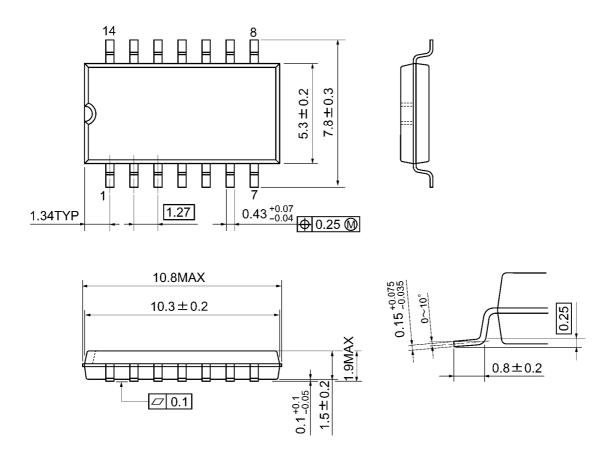
## **Input Equivalent Circuit**





## **Package Dimensions**

SOP14-P-300-1.27A Unit: mm



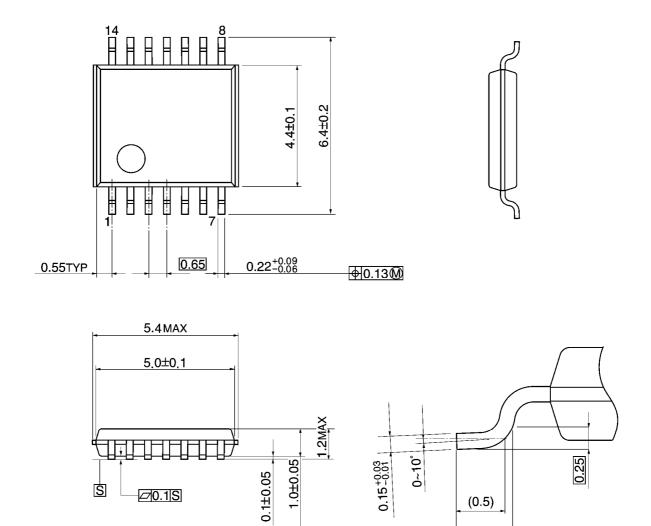
Weight: 0.18 g (typ.)



## **Package Dimensions**

TSSOP14-P-0044-0.65A

Unit: mm



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Weight: 0.06 g (typ.)

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Ø.1S

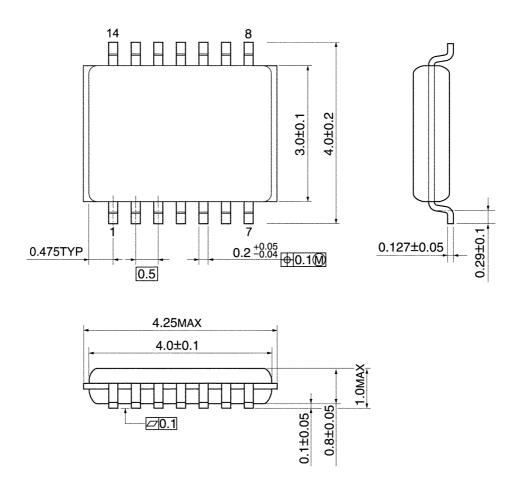
(0.5)

0.45~0.75



## **Package Dimensions**

VSSOP14-P-0030-0.50 Unit: mm



9

Weight: 0.02 g (typ.)

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